CPC   COOPERATIVE PATENT CLASSIFICATION

C    CHEMISTRY; METALLURGY
    (NOTES omitted)

CHEMISTRY

C09    DYSES; PAINTS; POLISHES; NATURAL RESINS; ADHESIVES; COMPOSITIONS NOT OTHERWISE PROVIDED FOR; APPLICATIONS OF MATERIALS NOT OTHERWISE PROVIDED FOR

C09G   POLISHING COMPOSITIONS OTHER THAN FRENCH POLISH; SKI WAXES

1/00   Polishing compositions (French polish C09F 11/00; detergents C11D)
1/02   . containing abrasives or grinding agents {(abrasives as such C09K 3/14; polishing of semi-conductors H01L)}
1/04   . Aqueous dispersions (C09G 1/02 takes precedence)
1/06   . Other polishing compositions
1/08   . . based on wax
1/10   . . . based on mixtures of wax and natural or synthetic resin
1/12   . . . . mixtures of wax and silicon-containing polycondensates
1/14   . . based on non-waxy substances
1/16   . . . on natural or synthetic resins
1/18   . . . on other substances

3/00   Ski waxes